

# ULTRA-LOW POWER OSCILLATOR 1-26MHz

## SERIES „ULPO“

### FEATURES

- + Ultra Low Power High Precision Oscillator for Low Cost
- + Excellent long time reliability
- + Ultra-small 1.5 mm x 0.8 mm package
- + 1 to 26 MHz with 6 decimal places of accuracy
- + Ultra low power consumption of 50 µA at 2.048 MHz
- + Operating temperature from -40°C to 85°C (ask for -40/+105°C)
- + RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free / MSL1@260°

### DESCRIPTION AND APPLICATIONS

The ULPO is the industry's smallest and the lowest power MHz oscillator. With its ultra low power consumption, the ULPO enables longer battery life time for a wearable, IoT or mobile device compared to a quartz-based oscillator or resonator.

The combination of lowest power, smallest package and flexible output frequency makes it ideal for power sensitive and space constrained applications including:

- |                           |                                 |
|---------------------------|---------------------------------|
| + Smart Phones            | + GPS                           |
| + Tablets                 | + Smart Metering                |
| + Ultra-Small Notebook PC | + Sport video cams              |
| + Battery powered devices | + Home Automation               |
| + Wearables               | + Health and Medical monitoring |
| + IoT devices             | + Hearing aids                  |

### GENERAL DATA<sup>(1,2)</sup>

PARAMETER AND CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
<b>FREQUENCY RANGE</b>						
Output Frequency Range	F	1	-	26	MHz	Standard frequencies (See Table 1.)
<b>FREQUENCY STABILITY AND AGING</b>						
Initial Tolerance	F_tol	-15	-	+15	PPM	Frequency offset at 25°C
Frequency Stability	F_stab	-100	-	+100	PPM	Inclusive of initial tolerance, and variations over operating temperature, rated power supply voltage and output load. Contact PETERMANN-TECHNIK for ±25 or ±50 ppm options.
First Year Aging	F_1 year	-3	-	+3	PPM	At 25°C
<b>OPERATING TEMPERATURE RANGE</b>						
Operating Temperature Range	T_use	-20	-	+70	°C	Extended Commercial
		-40	-	+85	°C	Industrial. Contact PETERMANN-TECHNIK for -40°C to 105°C option.
Storage Temperature Range	T_stor	-55	-	+125	°C	Storage
<b>SUPPLY VOLTAGE AND CURRENT CONSUMPTION</b>						
Supply Voltage	VDD	1.62	1.8	1.98	V	Contact PETERMANN-TECHNIK for 3.3V option
Current Consumption	IDD	50	-	320	µA	Depending on Frequency (See Table 1.)
Standby Current	I_std	-	0.7	1.3	µA	ST pin =HIGH, Output is weekly pulled down
<b>LVC MOS OUTPUT CHARACTERISTICS</b>						
Duty Cycle	DC	45	-	55	%	
Rise/ Fall Time	T_r, T_f	-	4	8	ns	20% - 80%. Contact PETERMANN-TECHNIK for other programmable rise/fall options
Output High Voltage	VOH	90%	-	-	VDD	I <sub>OH</sub> = -0.5 mA
Output Low Voltage	VOL	-	-	10%	VDD	I <sub>OL</sub> = 0.5 mA
<b>INPUT CHARACTERISTICS</b>						
Input High Voltage	VIH	80%	-	-	VDD	
Input Low Voltage	VIL	-	-	20%	VDD	
Input Slew Rate	In-slew	10	-	-	V/µs	
Input Pull-down Impedance	Z_in	300	-	-	kΩ	Active mode (ST pin = LOW)
		2.5	4	-	MΩ	Standby mode (ST pin = HIGH)

## GENERAL DATA (continued)

PARAMETER AND CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
<b>JITTER PERFORMANCE</b>						
RMS Period Jitter	T_jitt	-	75	110	ps	f=6.144 MHz
RMS Phase Jitter	T_phj	-	0.8	2.5	ns	f = 6.144 MHz, Integration bandwidth = 100 Hz to 40 kHz. Note 3
<b>LVC MOS OUTPUT (STANDARD VERSION)</b>						
Startup Time	T_start	-	75	150	ms	Measured from the time VDD reaches 90% of its final value
Startup Time	T_stdby	-	-	20	µs	Measured from the time ST pin crosses 50% threshold
Resume Time	T_resume	-	2	3	ms	Measured from the time ST pin crosses 50% threshold

### Notes:

1. Current consumption with load is a function of the output frequency and output load. For any given output frequency, the capacitive loading will increase current consumption equal to  $C_{load} \cdot VDD \cdot f$  (MHz).
2. All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at 25°C and nominal supply voltage.
3. Max spec inclusive of 25 mV peak-to-peak sinusoidal noise on VDD. Noise frequency 100 Hz to 20 MHz.

TABLE 1. STANDARD FREQUENCIES

STANDARD FREQUENCIES	CURRENT CONSUMPTION
2.048 MHz	50 µA
4 MHz	70 µA
6.144 MHz	90 µA
8 MHz	120 µA
12 MHz	160 µA
12.288 MHz	160 µA
16 MHz	200 µA
19.2 MHz	230 µA
24 MHz	300 µA
26 MHz	320 µA

## PIN DESCRIPTION

PIN	SYMBOL	I/O	FUNCTIONALITY
1	ST	Input	L: Specified frequency output H: Output is low (weak pull down). Device goes to the standby mode. Supply current reduces to I_std.
2	OUT	Output	LVC MOS clock output
3	VDD	Power	Supply voltage. Bypass with a 0.01µF X7R capacitor.
4	GND	Power	Connect to ground

FIGURE 1. PIN ASSIGNMENTS (TOP VIEW)

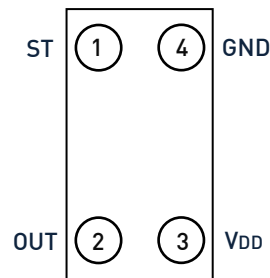
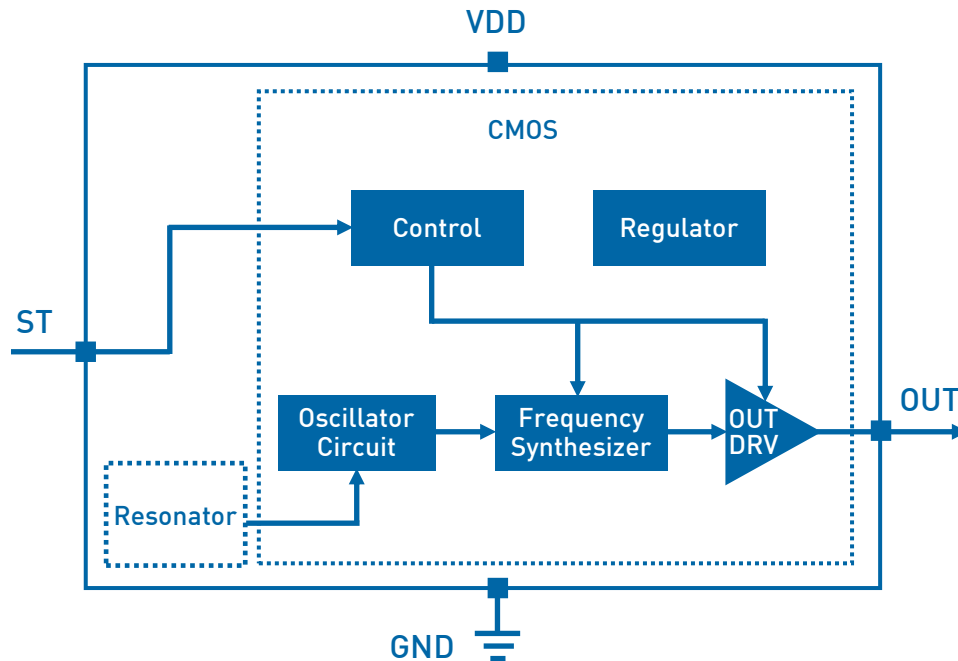


FIGURE 2. BLOCK DIAGRAM



## DEVICE OPERATING MODES AND OUTPUTS

The ULPO supports  $\leq 0.7 \mu\text{A}$  standby mode for battery-powered and other power sensitive applications. The switching between the active and standby modes is controlled by the logic level on the ST pin.

TABLE 2. OPERATING MODES AND OUTPUT STATES

ST Pin	Mode	OUTPUT	Max Current Consumption
LOW	Active	Specified frequency	60 $\mu\text{A}$ @ 3.072 MHz
FLOAT	Active with 200 k $\Omega$ internal pull-down	Specified frequency	60 $\mu\text{A}$ @ 3.072 MHz
HIGH	Standby	Hi-Z pulled-down with 1M $\Omega$ impedance	1.3 $\mu\text{A}$

## ACTIVE MODE

The ULPO operates in the active mode when the ST pin is at logic LOW or FLOAT. In the active mode, the device uses the on-chip frequency synthesizer to generate an output from the internal resonator reference. The frequency of the output is factory programmed based on the device ordering code.

## STANDBY MODE

The ULPO operates in the standby mode when the ST pin is at logic HIGH. In the standby mode, all internal circuits with the exception of the oscillator circuit and the ST pin detection logic are turned off to reduce power consumption. While in standby mode, the input impedance of the ST pin is increased to further reduce system level power consumption. The output driver of the device in the standby mode is weakly pulled-down with a 1 M $\Omega$  impedance.

## OUTPUT DURING STARTUP AND RESUME

The ULPO starts up with the output disabled. The output is enabled once all internal circuit blocks are active, and logic LOW or FLOAT is detected on the ST pin.

As shown in Table 2, logic HIGH at ST pin forces the ULPO into “standby” state, causing the output to disable. Upon pulling ST pin LOW, the device enters “resume” state, keeping the output disabled. Once “resume” state ends, the device output enables. The first clock pulse after startup or resume is accurate to the rated stability.

## LOW POWER DESIGN GUIDELINES

For high EM noise environments, we recommend the following design guidelines:

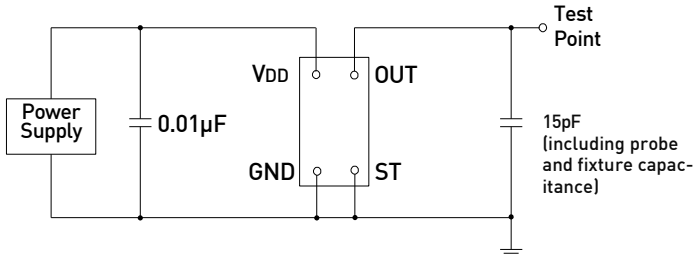
- + Place oscillator as far away from EM noise sources as possible (e.g., high-voltage switching regulators, motor drive control).
- + Route noisy PCB traces, such as digital data lines or high di/dt power supply lines, away from the oscillator.
- + Place a solid GND plane underneath the oscillator to shield the oscillator from noisy traces on the other board layers.

## MANUFACTURING GUIDELINES

- + No Ultrasonic or Megasonic Cleaning: Do not subject the ULPO to an ultrasonic or megasonic cleaning environment. Permanent damage or long-term reliability issues to the device may occur in such an event.
- + Applying board-level underfill (BLUF) to the device is acceptable, but will cause a slight shift of few PPM in the initial frequency tolerance. Tested with UF3810, UF3808, and FP4530 underfill.
- + Reflow profile, per JESD22-A113D.

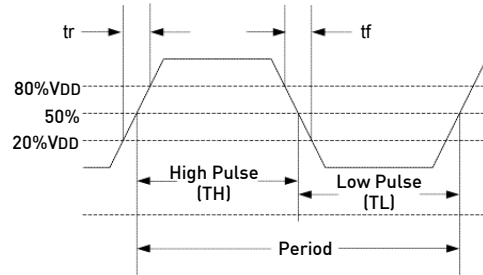
## TEST CIRCUIT AND WAVEFORM

FIGURE 3. TEST CIRCUIT



Notes:  
 4. Duty Cycle is computed as  $Duty\ Cycle = TH/Period$

FIGURE 4. WAVEFORM<sup>(3)</sup>



## TIMING DIAGRAMS

FIGURE 5. STARTUP TIMING

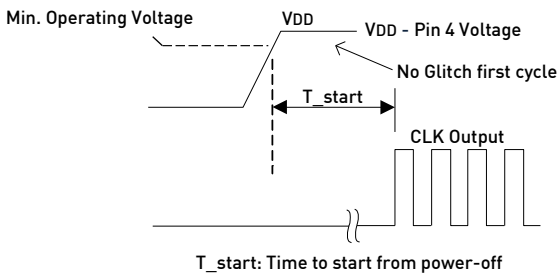


FIGURE 6. RESUME TIMING

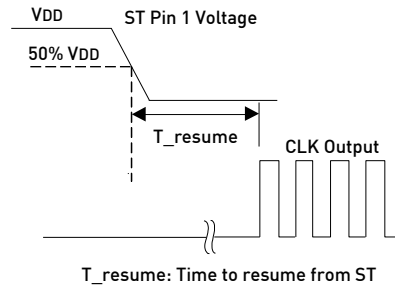
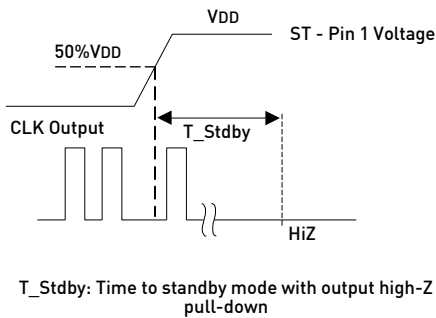


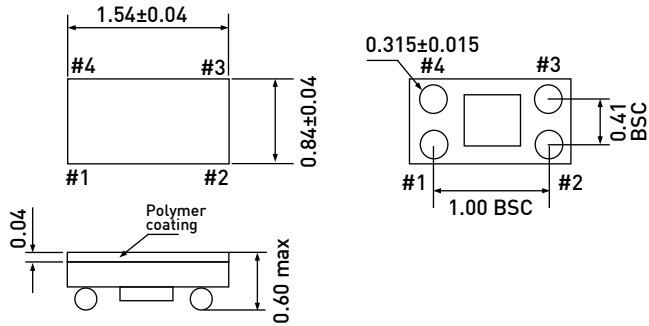
FIGURE 7. STANDBY TIMING



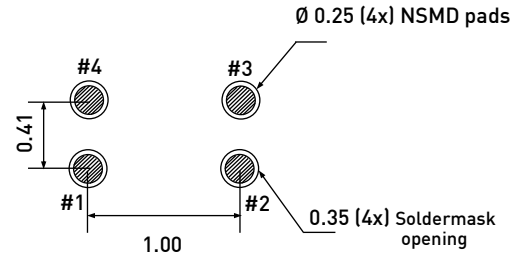
## DIMENSIONS AND PATTERNS

### PACKAGE SIZE – DIMENSIONS (UNIT:MM)

1.55 X 0.84 MM



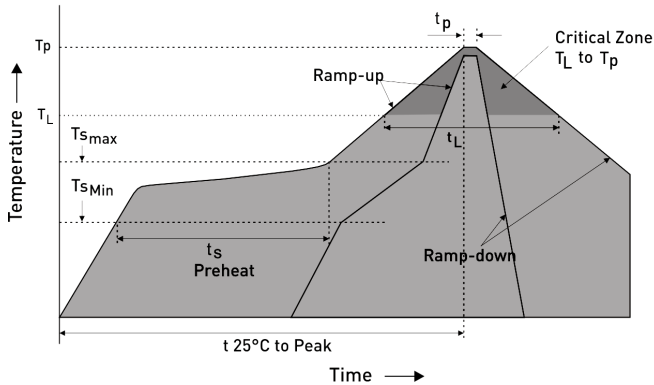
### RECOMMENDED LAND PATTERN (UNIT:MM)



(soldermask openings shown with heavy dashed line)

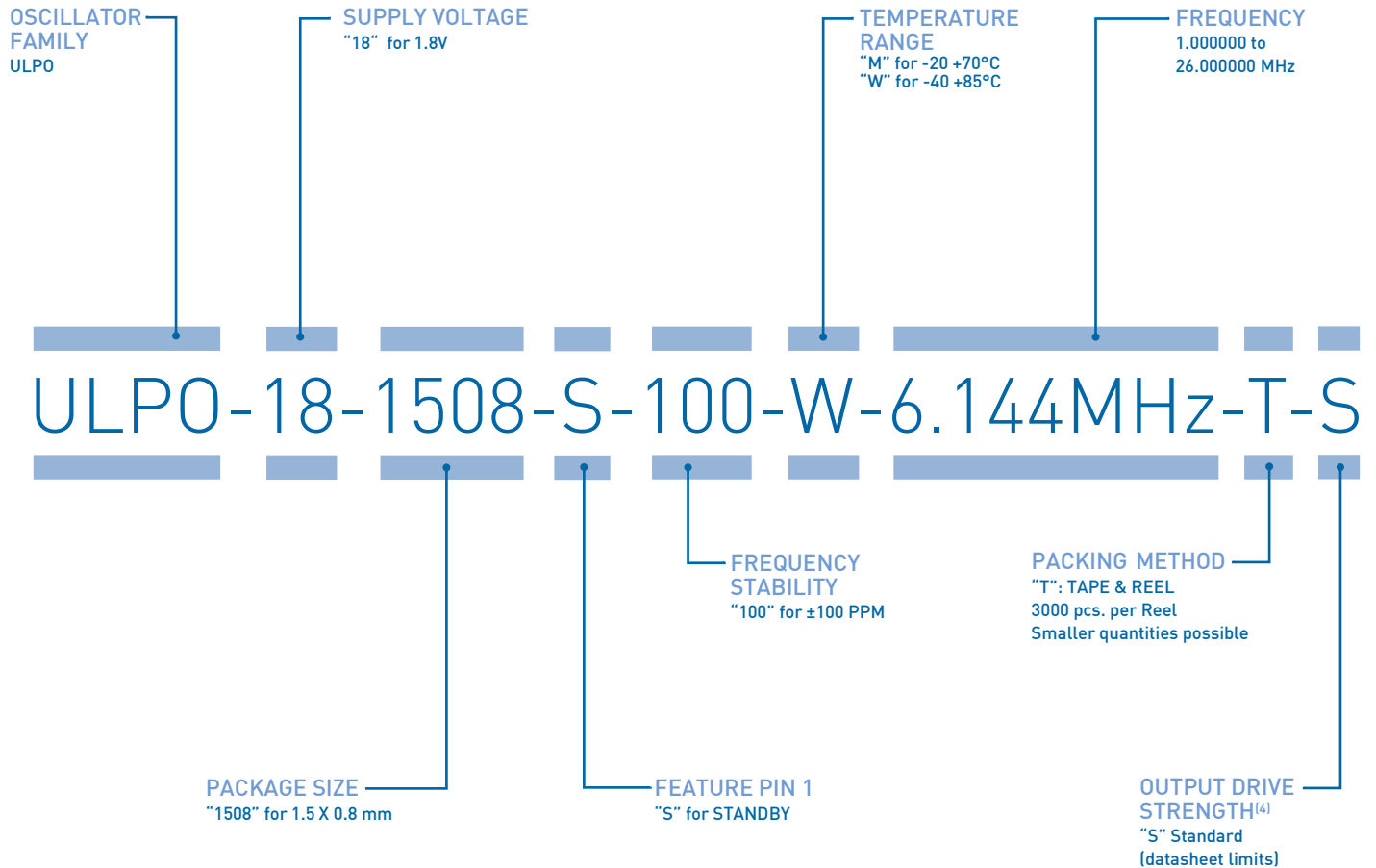
Recommended 4-mil (0.1mm) stencil thickness

### REFLOW SOLDER PROFILE



IPC/JEDEC Standard	IPC/JEDEC J-STD-020
Moisture Sensitivity Level	Level 1
TS MAX to TL (Ramp-up Rate)	3°C/second Maximum
Preheat	
- Temperature Minimum (TS MIN)	150°C
- Temperature Typical (TS TYP)	175°C
- Temperature Typical (TS MAX)	200°C
- Time (tS)	60 - 180 Seconds
Ramp-up Rate (TL to TP)	3°C/second Maximum
Time Maintained Above:	
- Temperature (TL)	217°C
- Time (TL)	60 - 150 Seconds
Peak Temperature (TP)	260°C Maximum
Target Peak Temperature (TP Target)	255°C
Time within 5°C of actual peak (tP)	20 - 40 Seconds
Max. Number of Reflow Cycles	3
Ramp-down Rate	6°C/second Maximum
Time 25°C to Peak Temperature (t)	8 minutes Maximum

## ORDERING INFORMATION



**Notes:**

5. Contact PETERMANN-TECHNIK for other drive strength options that result in different rise/fall time for any given output load.

EXAMPLE: ULPO-18-1508-S-100-W-6.144MHz-T-S  
[PLEASE CLICK HERE TO CREATE YOUR OWN ORDERING CODE](#)

## REVISION HISTORY

REVISION	RELEASE DATE	AMENDMENTS SUMMARY
0.0	OKTOBER 2015	+ Initial Data Sheet (SPEC 01/REV.00)
0.1	MARCH 2016	+ Revised initial tolerance, current consumption, standby current, input high/low voltage for ST, input pull-down impedance, startup/resume time and RMS period/phase jitter in Table General Data. + Added standard additional operating temperature range (-40°C to 105°C) + Added typ. current consumption



# PREMIUM QUALITY BY PETERMANN-TECHNIK



OUR COMPANY IS CERTIFIED ACCORDING TO ISO 9001:2015 IN OCTOBER 2016 BY THE DMSZ CERTIFIKATION GMBH.

THIS IS FOR YOU TO ENSURE THAT THE PRINCIPLES OF QUALITY MANAGEMENT ARE FULLY IMPLEMENTED IN OUR QUALITY MANAGEMENT SYSTEM AND QUALITY CONTROL METHODS ALSO DOMINATE OUR QUALITY STANDARDS.